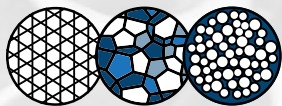


MetFoam2019



11th International Conference on Porous Metals and Metallic Foams

August 20–23, 2019

DoubleTree by Hilton Hotel • Dearborn, Michigan, USA

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Topics planned for MetFoam 2019 include, but are not limited to:

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- Characterization
- Properties of compressed and un-compressed foam
 - Mechanical properties
 - Other properties
- Design of porous metals, metallic foams, and lattice structures
- Fluid, heat, and mass transfer
- Porous biomaterials
- Nanoporous metals
- Industrial applications of porous metals and metallic foams

Visit www.tms.org/MetFoam2019 to learn more about the technical topics and other plans for the conference.

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